

# 1.5A, 1000V Fast Avalanche Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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 The superior avalanche capability of BYG21MH is specially suited for free-wheeling, clamping, snubber, demagnetization in power supplies and other power switching applications.

#### **MECHANICAL DATA**

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.064g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	1.5	Α		
$V_{RRM}$	1000	V		
I <sub>FSM</sub>	50	Α		
$T_{JMAX}$	150	°C		
Package	DO-214AC (SMA)			
Configuration	Single die			









DO-214AC (SMA)



PARAMETER	SYMBOL	BYG21MH	UNIT
Marking code on the device		BYG21M	
Repetitive peak reverse voltage	$V_{RRM}$	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	700	V
Forward current	I <sub>F</sub>	1.5	А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50	А
Pulse energy in avalanche mode, non-repetitive (Inductive load switch off ), $I_{(BR)R} = 1.23A$	E <sub>RSM</sub>	30	mJ
Junction temperature	$T_J$	- 55 to +150	°C
Storage temperature	T <sub>STG</sub>	- 55 to +150	°C



# Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	20	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	70	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C	\/	-	1.5	V
roiward voitage	$I_F = 1.5A, T_J = 25^{\circ}C$	- V <sub>F</sub>	-	1.6	V
	T <sub>J</sub> = 25°C		-	1	μA
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 100°C	I <sub>R</sub>	-	10	μA
	T <sub>J</sub> = 125°C		-	50	μA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	Сл	13	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	120	ns

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE PACKAGE PACKING				
BYG21MH	DO-214AC (SMA)	7,500 / Tape & Reel		



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

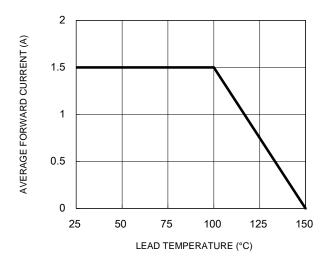


Fig.3 Typical Reverse Characteristics

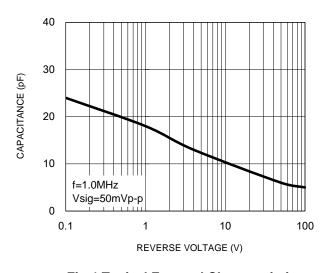
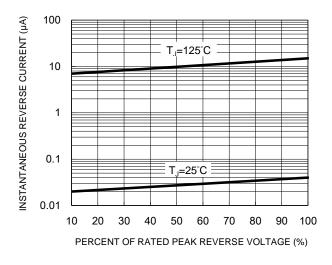


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



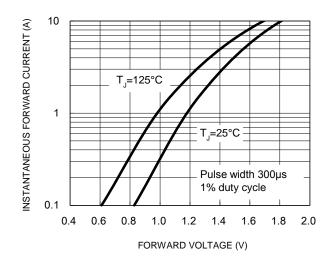
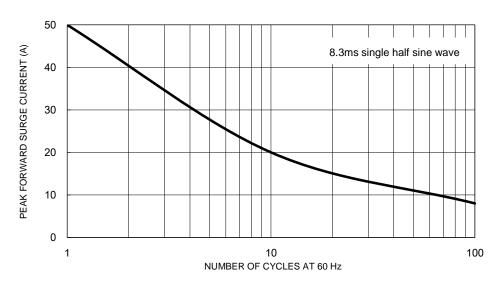
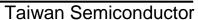


Fig.5 Maximum Non-Repetitive Forward Surge Current

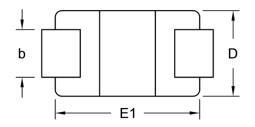


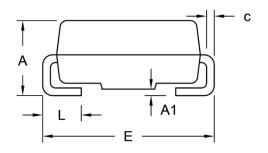




# **PACKAGE OUTLINE DIMENSIONS**

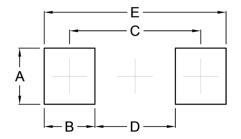
# DO-214AC (SMA)





DIM.	Unit	Unit (mm)		inch)
DIN.	Min.	Max.	Min.	Max.
Α	1.99	2.50	0.078	0.098
A1	0.10	0.20	0.004	0.008
b	1.27	1.58	0.050	0.062
С	0.15	0.31	0.006	0.012
D	2.29	2.83	0.090	0.111
E	4.95	5.33	0.195	0.210
E1	4.06	4.60	0.160	0.181
L	0.90	1.41	0.035	0.056

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

# **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YW = Date Code F = Factory Code





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